

## Features

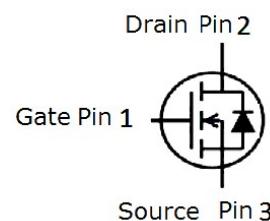
- Enhancement mode
- Very Low on-resistance  $R_{DS(on)}$
- Fast Switching and High efficiency
- 100% Avalanche test

$V_{DS}$	100	V
$R_{DS(on),TYP} @ V_{GS}=10\text{ V}$	2.6	$\text{m}\Omega$
$I_D$	320	A

**TO-247**

**Halogen-Free**

Part ID	Package Type	Marking	Packing
VS320N10AU	TO-247	320N10A	30pcs/Tube



## Maximum ratings, at $T_A = 25^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit
$V(BR)DSS$	Drain-Source breakdown voltage	100	V
$V_{GS}$	Gate-Source voltage	$\pm 25$	V
$I_S$	Diode continuous forward current	$T_C = 25^\circ\text{C}$	A
$I_D$	Continuous drain current @ $V_{GS}=10\text{V}$	$T_C = 25^\circ\text{C}$	A
		$T_C = 100^\circ\text{C}$	A
$I_{DM}$	Pulse drain current tested ①	$T_C = 25^\circ\text{C}$	A
$I_{DSM}$	Continuous drain current @ $V_{GS}=10\text{V}$	$T_A = 25^\circ\text{C}$	A
		$T_A = 70^\circ\text{C}$	A
$EAS$	Avalanche energy, single pulsed ②	625	mJ
$P_D$	Maximum power dissipation	$T_C = 25^\circ\text{C}$	W
		$T_C = 100^\circ\text{C}$	W
$P_{DSM}$	Maximum power dissipation ③	$T_A = 25^\circ\text{C}$	W
		$T_A = 70^\circ\text{C}$	W
$T_{STG,TJ}$	Storage and Junction Temperature Range	-55 to 175	°C

## Thermal Characteristics

Symbol	Parameter	Typical	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.3	0.36	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	50	60	°C/W

**Electrical Characteristics**

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_j=25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	100	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_j=125^\circ\text{C}$ )	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 25\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.6	3.1	3.6	V
$R_{\text{DS}(\text{on})}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=120\text{A}$	--	2.6	3.1	$\text{m}\Omega$
		$T_j=100^\circ\text{C}$	--	3.9	--	$\text{m}\Omega$

**Dynamic Electrical Characteristics @  $T_j = 25^\circ\text{C}$  (unless otherwise stated)**

C <sub>iss</sub>	Input Capacitance	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	23480	31305	41635	pF
C <sub>oss</sub>	Output Capacitance		1000	1335	1775	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		325	430	570	pF
R <sub>g</sub>	Gate Resistance	f=1MHz	0.2	0.7	5	$\Omega$
Q <sub>g</sub>	Total Gate Charge	$V_{\text{DS}}=50\text{V}, I_{\text{D}}=80\text{A}, V_{\text{GS}}=10\text{V}$	--	452	600	nC
Q <sub>gs</sub>	Gate-Source Charge		--	131	174	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	119	179	nC

**Switching Characteristics**

T <sub>d(on)</sub>	Turn-on Delay Time	$V_{\text{DD}}=50\text{V}, I_{\text{D}}=80\text{A}, R_{\text{G}}=3\Omega, V_{\text{GS}}=10\text{V}$	--	77	--	ns
T <sub>r</sub>	Turn-on Rise Time		--	142	--	ns
T <sub>d(off)</sub>	Turn-Off Delay Time		--	190	--	ns
T <sub>f</sub>	Turn-Off Fall Time		--	137	--	ns

**Source- Drain Diode Characteristics@  $T_j = 25^\circ\text{C}$  (unless otherwise stated)**

V <sub>SD</sub>	Forward on voltage	$I_{\text{SD}}=120\text{A}, V_{\text{GS}}=0\text{V}$	--	0.9	1.2	V
T <sub>rr</sub>	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{SD}}=80\text{A}, V_{\text{GS}}=0\text{V}$	--	63	--	ns
Q <sub>rr</sub>	Reverse Recovery Charge		--	144	--	nC

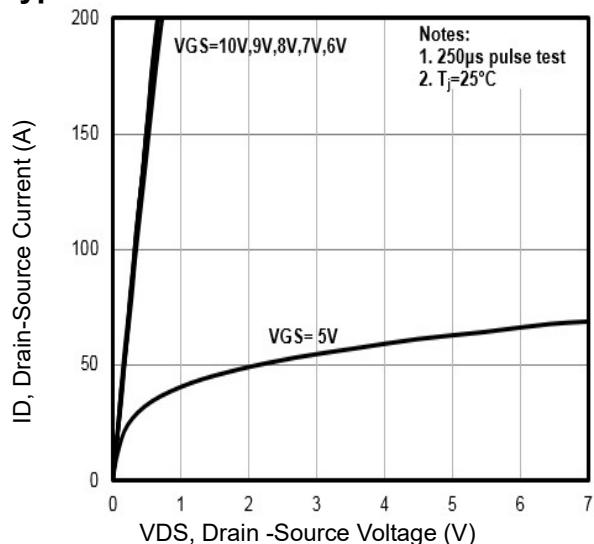
NOTE: ① Repetitive rating; pulse width limited by max junction temperature.

② Limited by  $T_{j\text{max}}$ , starting  $T_j = 25^\circ\text{C}$ ,  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 50\text{A}$ ,  $V_{GS} = 10\text{V}$ . Part not recommended for use above this value

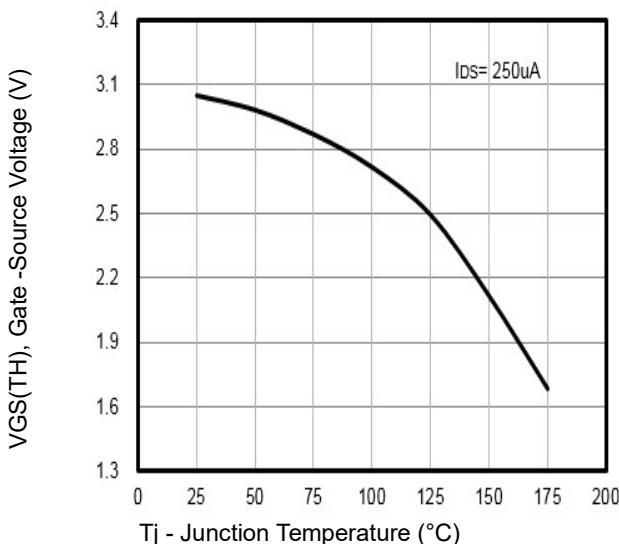
③ The power dissipation  $P_{DSM}$  is based on  $R_{\theta JA}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ .

④ Pulse width  $\leq 380\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

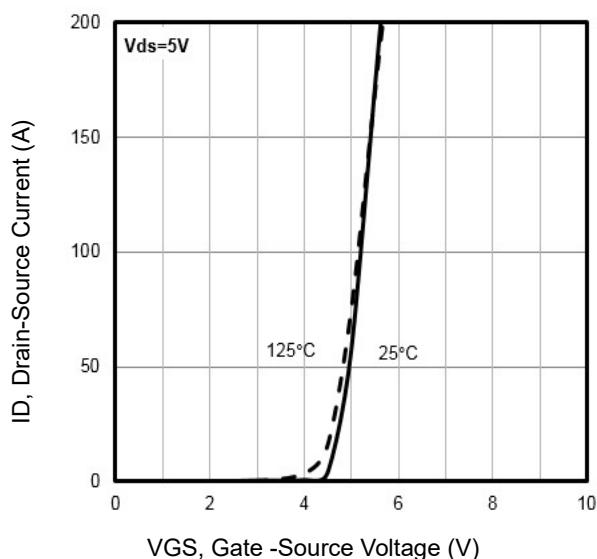
## Typical Characteristics



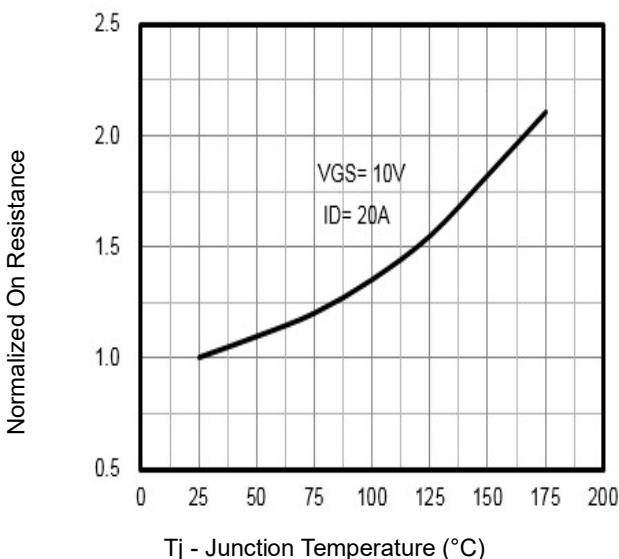
**Fig1.** Typical Output Characteristics



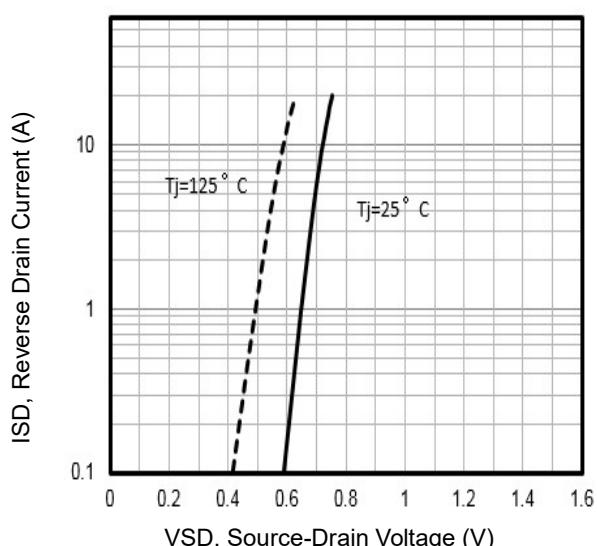
**Fig2.**  $V_{GS(TH)}$  Gate -Source Voltage Vs.  $T_j$



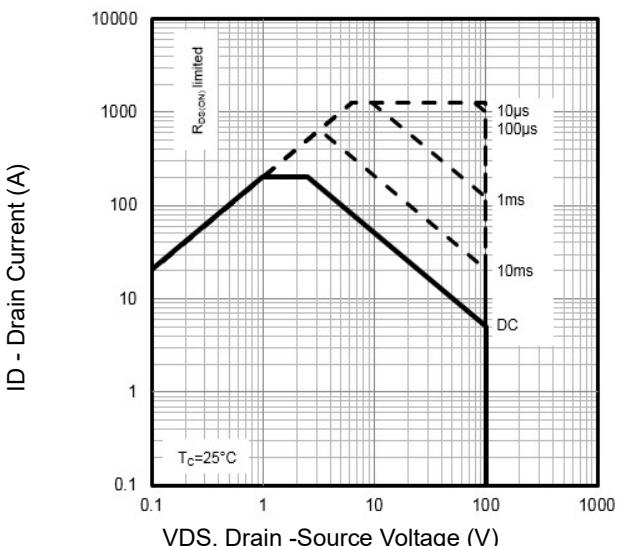
**Fig3.** Typical Transfer Characteristics



**Fig4.** Normalized On-Resistance Vs.  $T_j$

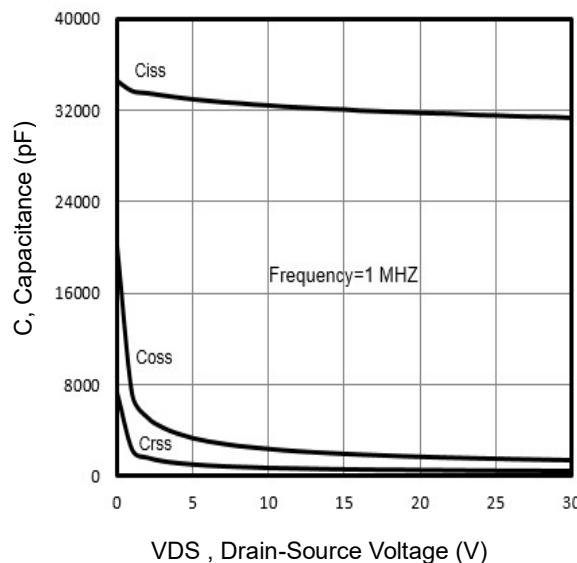


**Fig5.** Typical Source-Drain Diode Forward Voltage

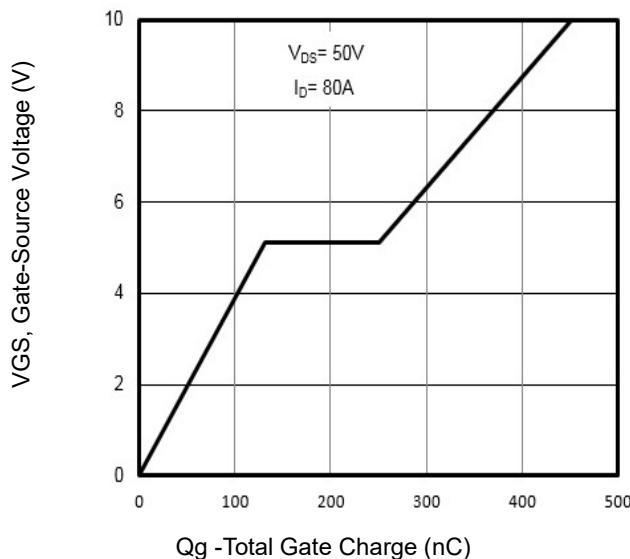


**Fig6.** Maximum Safe Operating Area

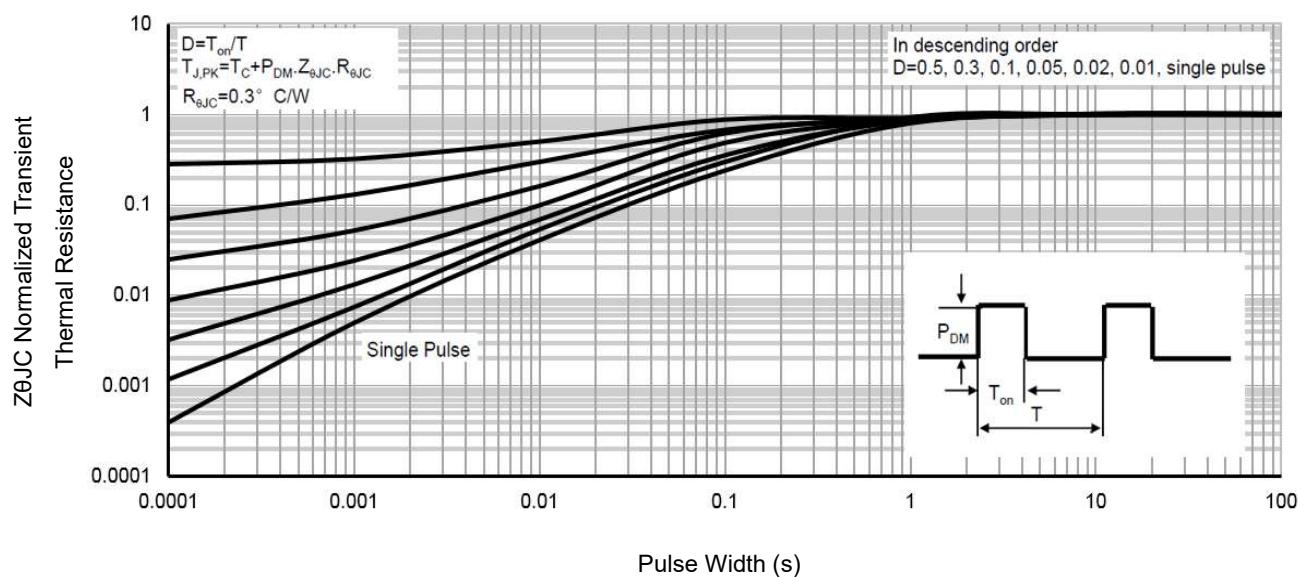
## Typical Characteristics



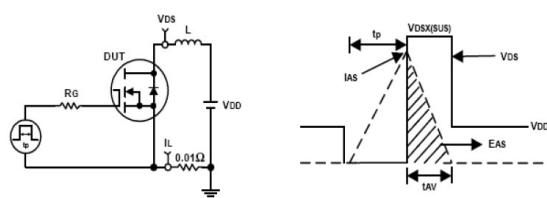
**Fig7.** Typical Capacitance Vs.Drain-Source Voltage



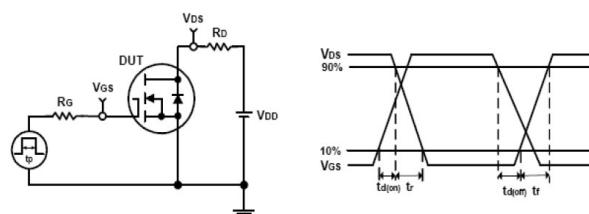
**Fig8.** Typical Gate Charge Vs.Gate-Source Voltage



**Fig9.** Normalized Maximum Transient Thermal Impedance

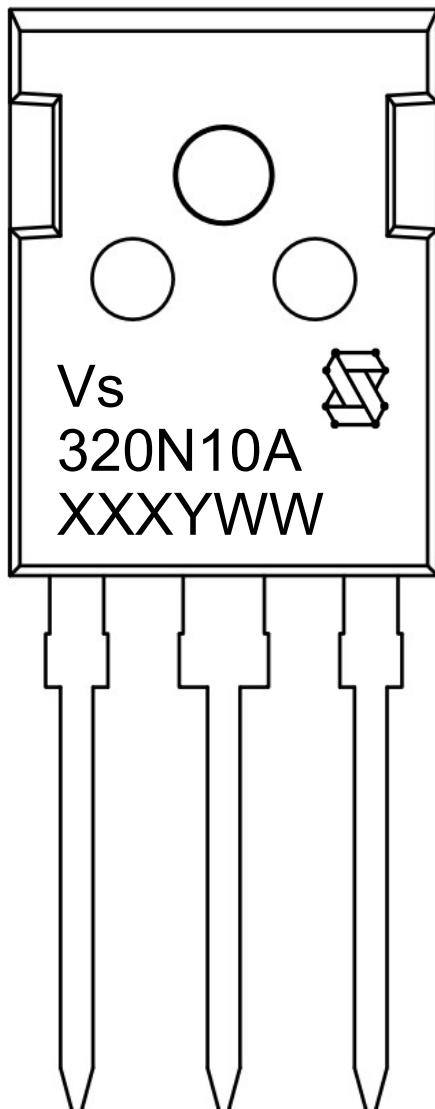


**Fig10.** Unclamped Inductive Test Circuit and waveforms



**Fig11.** Switching Time Test Circuit and waveforms

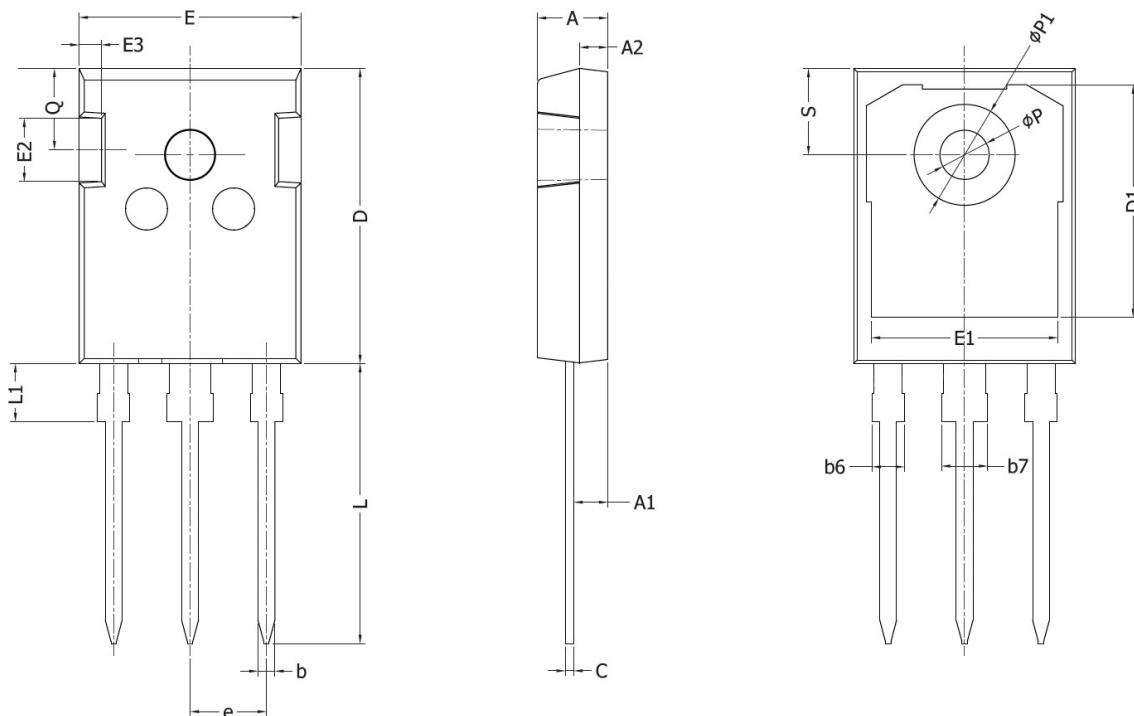
## Marking Information



1st line: Vergiga Code (Vs), Vergiga Logo  
 2nd line: Part Number (320N10A)  
 3rd line: Date code (XXXYWW)  
 XXX: Wafer Lot Number Code , code changed with Lot Number  
 Y: Year Code , refer to table below  
 WW: Week Code (01 to 53)

Code	C	D	E	F	G	H	J	K	L	M	N	P	Q	R	S	T
Year	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030

### TO-247 Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Nom	Max
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b6	1.91	--	2.21
b7	2.91	--	3.21
C	0.51	0.61	0.75
D	20.80	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.40	--	5.20
E3	1.50	1.60	1.70
e	5.44 BSC		
L	19.80	19.92	20.22
L1	--	--	4.30
phi_P	3.40	3.60	3.80
phi_P1	7.00	--	7.40
Q	5.60	5.80	6.00
S	6.05	6.15	6.25

#### Notes:

1. Package Reference: JEDEC TO-247, Variation AD.
2. All Dimensions Are In mm.
3. Slot Required, Notch May Be Rounded
4. Dimension D & E Do Not Include Mold Flash. Mold Flash Shall Not Exceed 0.127mm Pre Side.
5. Thermal Pad Contour Optional Within Dimension D1 & E1.
6. Lead Finish Uncontrolled In L1.

### Customer Service

Sales and Service:

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